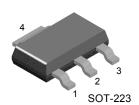


NZT660/NZT660A PNP Low Saturation Transistor

· These devices are designed with high current gain and low saturation voltage with collector currents up to 3A continuous.



1. Base 2. Collector 3. Emitter

Absolute Maximum Ratings* Ta=25°C unless otherwise noted

Symbol	Parameter	NZT660	NZT660A	Units
V _{CEO}	Collector-Emitter Voltage	60	60	V
V _{CBO}	Collector-Base Voltage	80	60	V
V _{EBO}	Emitter-Base Voltage	5	5	V
I _C	Collector Current - Continuous	3	3	Α
T _J , T _{STG}	Operating and Storage Junction Temperature Range	- 55 ~ +150	- 55 ~ +150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

Electrical Characteristics T_a = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Charac	Off Characteristics						
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = 10mA	60			V	
BV _{CBO}	Collector-Base Breakdown Voltage	I _C = 100μA NZT660 NZT660A	80 60			V V	
BV _{EBO}	Emitter-Base Breakdown Voltage	I _E = 100μA	5			V	
I _{CBO}	Collector-Base Cutoff Current	V _{CB} = 30V V _{CB} = 30V, T _A = 100°C			100 10	nA μA	
I _{EBO}	Emitter-Base Cutoff Current	V _{EB} = 4V			100	nA	
On Charac	On Characteristics *						
h _{FE}	DC Current Gain	$ \begin{aligned} & I_{C} = 100 \text{mA, V}_{CE} = 2 \text{V} \\ & I_{C} = 500 \text{mA, V}_{CE} = 2 \text{V} \\ & & \text{NZT660A} \\ & I_{C} = 1 \text{A, V}_{CE} = 2 \text{V} \\ & I_{C} = 3 \text{A, V}_{CE} = 2 \text{V} \end{aligned} $	70 100 250 80 25		300 550		

¹⁾ These ratings are based on a maximum junction temperature of 150 $^{\circ}\text{C}.$

²⁾ These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 1A, I _B = 100mA I _C = 3A, I _B = 300mA NZT660 NZT660A			300 550 500	mV mV mV
V _{BE(sat)}	Base-Emitter Saturation Voltage	I _C = 1A, I _B = 100mA			1.25	V
V _{BE(on)}	Base-Emitter On Voltage	I _C = 1A, V _{CE} = 2V			1	V
Small Sign	Small Signal Characteristics					
C _{obo}	Output Capacitance	$V_{CB} = 10V, I_{E} = 0, f = 1MHz$			45	pF
f _T	Transition Frequency	I _C = 100mA, V _{CE} = 5V, f = 100MHz	75			MHz

^{*} Pulse Test: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2.0\%$

Thermal Characteristics T_a =25°C unless otherwise noted

Symbol	Parameter	NZT660/NZT660A	Units
P_{D}	Total Device Dissipation	2	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	°C/W

Typical Performance Characteristics

Figure 1. Base-Emitter Saturation Voltage vs Collector Current

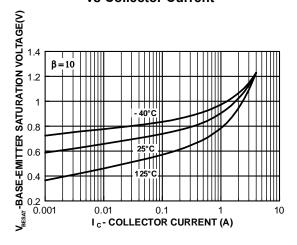


Figure 3. Collector-Emitter Saturation Voltage vs Collector Current

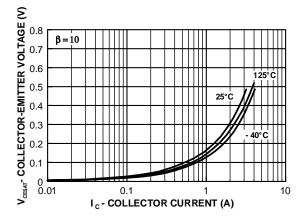


Figure 5. Current Gain vs Collector Current

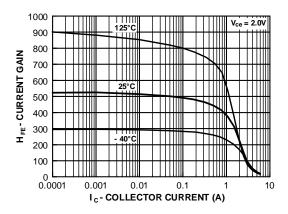


Figure 2. Base-Emitter On Voltage vs Collector Current

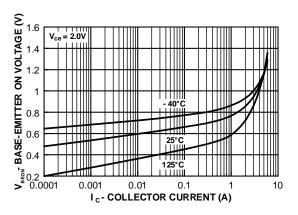
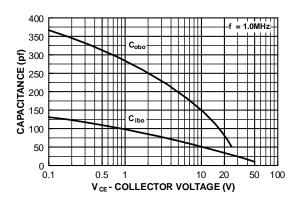
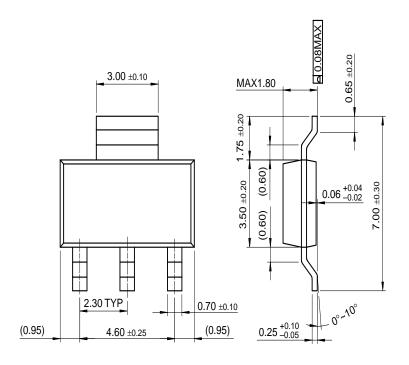


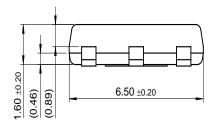
Figure 4. Input/Output Capacitance vs Reverse Bias Voltage



Mechanical Dimensions

SOT-223





Dimensions in Millimeters

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